# **Investor Conference**

Embedded wisely, Embedded widely





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### **Contents**



**Future Outlook** 



2

The Importance of PUF for **Random Number Generation** 







# Review of Operations

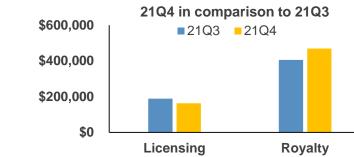
### **Q4 2021 Financial Results**

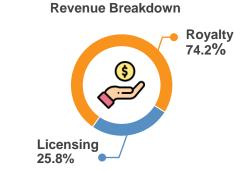
#### (thousands of NT dollars)

	Q4 2021 (Unaudited)	Q3 2021	Change (QoQ)	Q4 2020	Change (YoY)	FY 2021 (Unaudited)	FY 2020	Change (YoY)
Revenue	631,398	594,277	6.2%	496,682	27.1%	2,363,824	1,776,653	33.0%
Gross Margin	100%	100%	-	100%	-	100%	100%	-
Operating Expenses	299,677	277,611	7.9%	261,327	14.7%	1,095,012	954,067	14.8%
Operating Income	331,721	316,666	4.8%	235,355	40.9%	1,268,812	822,586	54.2%
Operating Margin	52.5%	53.3%	-0.8ppt	47.4%	5.1ppts	53.7%	46.3%	7.4ppts
*Net Income	287,263	277,181	3.6%	193,343	48.6%	1,101,157	707,999	55.5%
Net Margin	45.2%	46.3%	-1.1ppts	38.7%	6.5ppts	46.3%	39.8%	6.5ppts
EPS (NT\$)	3.86	3.72	3.8%	2.60	48.5%	14.78	9.52	55.3%
ROE	51.4%	53.2%	-1.8ppts	41.8%	9.6ppts	49.3%	38.3%	11.0ppts

\*Net income attributable to the Shareholders of the Company

### **Revenue in Different Stream**





#### Revenue

NT\$ Thousands	Q4 2021	Q3 2021	Change (QoQ)	Q4 2020	Change (YoY)	FY 2021	FY 2020	Change (YoY)
Licensing	162,632	188,667	-13.8%	154,472	5.3%	702,851	490,105	43.4%
Royalty	468,766	405,610	15.6%	342,210	37.0%	1,660,973	1,286,548	29.1%
Total	631,398	594,277	6.2%	496,682	27.1%	2,363,824	1,776,653	33.0%
US\$ Thousands	Q4 2021	Q3 2021	Change (QoQ)	Q4 2020	Change (YoY)	FY 2021	FY 2020	Change (YoY)

US\$ Thousands	Q4 2021	Q3 2021	Change (QoQ)	Q4 2020	Change (YoY)	FY 2021	FY 2020	Change (YoY)
Licensing	5,855	6,778	-13.6%	5,350	9.4%	25,092	16,610	51.1%
Royalty	16,788	14,584	15.1%	11,859	41.6%	59,173	43,586	35.8%
Total	22,643	21,362	6.0%	17,209	31.6%	84,265	60,196	40.0%

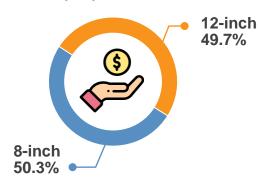
### **Revenue by Technology**

- ✓ The royalty revenue of NeoFuse up 27.3% QoQ and up 89.6% YoY due to increasing production from new and existing products from OLED, DDI, ISP, DTV, DRAM and others.
- ✓ PUF-based IP licensing in 2021 increased 140.9% YoY due to strong demand for PUF-based solution.

		Q4 2021							
	Total Revenue		Lice	ensing Reve	nue	Royalty Revenue			
Technology	% of Q4 Revenue	Change (QoQ)	Change (YoY)	% of Q4 Licensing	Change (QoQ)	Change (YoY)	% of Q4 Royalty	Change (QoQ)	Change (YoY)
NeoBit	35.2%	-3.6%	0.0%	14.5%	-39.7%	-11.2%	42.4%	3.7%	1.5%
NeoFuse	57.1%	22.0%	46.6%	63.4%	10.4%	-6.3%	54.8%	27.3%	89.6%
PUF-Based	3.0%	585.6%	647.7%	11.6%	580.4%	639.6%	0.1%	2,188.9%	100.0%
MTP	4.7%	-54.5%	13.9%	10.5%	-68.2%	11.3%	2.7%	6.3%	17.6%
	FY 2021								
	-	Total Revenu	е	Lice	ensing Rever	nue	Royalty Revenue		
Technology	% of FY 2021 Change Revenue (YoY)		% of FY 2021 Licensing	Change (YoY)		% of FY 202 <sup>°</sup> Royalty	1	Change (YoY)	
NeoBit	38.8% 1.5%		19.9%		45.9%	46.7%		-3.8%	
NeoFuse	51.9%		58.4%	55.4%		15.6%	50.4%		91.6%
PUF-Based	1.2%		142.7%	4.2%		140.9%	0.0%		100.0%
MTP	8.1%		119.2%	20.5%		220.8%	2.9%		12.1%

### **Royalty Revenue by Wafer Size**

#### **Q4 Royalty Breakdown**



- ✓ 8-inch wafers contributed 50.3% of royalty, up 11.2% sequentially and 13% YoY due to more production from PMIC, DDI, Fingerprint and Sensors.
- ✓ 12-inch wafers contributed 49.7% of royalty, up 20.3% QoQ and 74.4% YoY due to continuous production from WiFi 6/6E, OLED, ISP, DTV, DRAM and more.

Wafar Siza		Q4 2021	FY 2021		
Waler Size	Wafer Size % of Q4 Cha		Change (YoY)	% of FY 2021	Change (YoY)
8-Inch	50.3%	11.2%	13.0%	52.5%	8.9%
12-Inch	49.7%	20.3%	74.4%	47.5%	62.4%

# Future Outlook

### eMemory Embedded Everywhere

✓ eMemory's IP seeks to penetrate across all the applications



#### ✓ **Product Applications:**

eMemory's IPs are already applied into different applications, which includes PMIC, LCD Driver, Sensors, RFID, OLED Driver, Connectivity IC, DTV, STB, SSD Controller, Bluetooth, TDDI, MCU, Finger-print Sensor, Smart Meters, Surveillance, ISP, CIS, DRAM, Embedded Flash, IoT, AI and FPGA.

#### ✓ Future Target:

Tech

Core

AP, GPU, CPU, DPU, and Autonomous Driving



#### ✓ Product Application with PUF-based Security IP:

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PUF-based security IPs are being applied in AI, IoT, AIoT, GPS, PMIC and MCU.

#### ✓ PUF-based Security Solutions:

Automotive, Communication, Networking and Vertical Market.

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### **Our Perspectives**

Licensing & Royalty



✓ Licensing:

• Licensing revenue will grow due to the continued strong demand for our IPs, especially NeoFuse and PUF-related solutions.

#### ✓ Royalty:

- 8-inch royalties will continue to grow due to the demand and content increase for PMIC, MCU, Fingerprint, and Sensor-related in 5G, Automotive, and IoT-related applications.
- 12-inch royalties will have strong growth as customers are ramping up production for TDDI, OLED, ISP, DTV, STB, WiFi 6/6E, Bluetooth, Ethernet, Switch, TWS, DRAM and others.
- Royalties for 12/16nm and 7nm FinFET have also started to contribute in the fourth quarter and is expected to be the next growth driver after 28nm.

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### **Our Perspectives**

#### ✓ New Business Development:

- The focus of our new application development is in the field of security. NeoFuse is replacing secret key storage for eFuse, and applications are migrating to more advanced processes, and was also adopted by automotive applications in 6/7nm.
- Business activities for PUF-based security solutions are continuing to progress in IoT, Industrial IoT, AI, Blockchain, FPGA, Data Processor Unit (DPU), Mobile Storage (UFS) and Automotive applications.
- PUFrt was selected by Arm for the secure sub-system of the Armv9 confidential computing architecture. This is significant breakthrough for our IP to be adopted by leading processor application markets.

#### ✓ New IP Technology Development:

- Integrated NeoFuse and NeoPUF IP with high security function, was verified and designed in TSMC's N5 process, supporting high-end to mid-end Mobile, Consumer, AI, Networking, 5G Infrastructure, GPU, DPU and High-performance Computing.
- ReRAM IP has been qualified on the UMC 40nm process, and tape-out has begun for the 22nm process. ReRAM will extend to advanced process nodes and specialty processes such as BCD and high voltage.
- Continue to develop new security functional IPs, including PUF-based Security Co-Processors and PUF-based Security Elements.
- Develop NeoFlash in BCD as well as 28nm and below processes to solve the technology problem of traditional embedded Flash.

New Business & IP Technology Development



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# The Importance of PUF for Random Number Generation

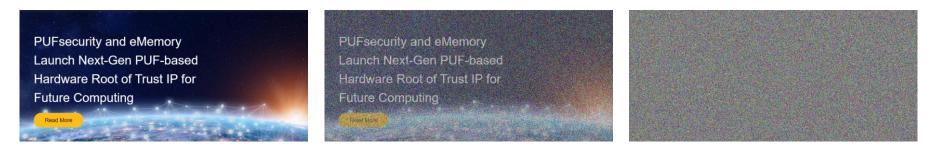


### **Revisiting the Goals of Security** Authenticity of both the sender & recipient (Authentication) Confidentiality of Data-in-transit (Encryption) ABC B A XYZ The Genuineness of information (Integrity) **Confidentiality of** Data-at-rest (Encryption) emem

### **Randomness is Pivotal in Security**

• Introducing unpredictability significantly improves security

Ex: Encrypting a message using random numbers of different quality



#### Original

#### **Poorly Random**

**Highly Random** 

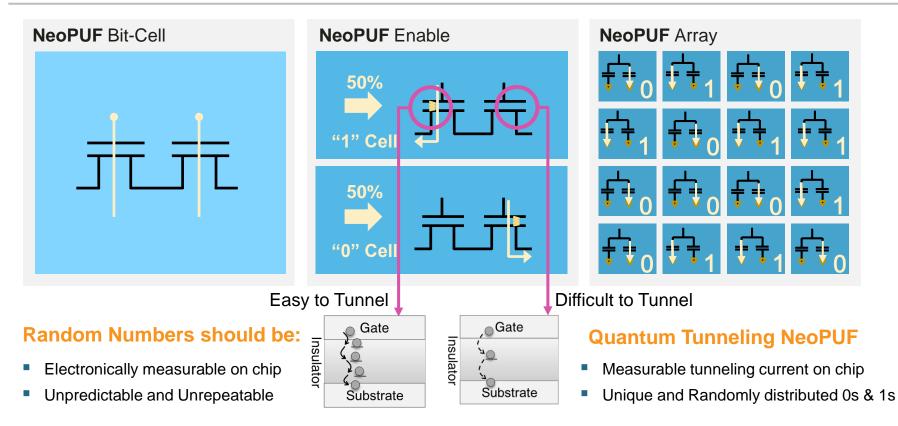
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#### "The strength of a security mechanism is directly proportional to the randomness of the number it uses"

### **Methods of Generating Random Numbers**

Software RNG	Hardware RNG
Generated from Computer Programs e.g. rand() commands	Extracted from physical sources e.g., intrinsic difference in materials
Pseudorandom	Truly Random
Requires initial seed	No seed is needed
Periodic up to a certain length	Not repeatable
Deterministic, thus reproducible Dependent Seed SW 001101010101011 RNG RNG Random Numbers	Non-reproducible Enrollment $\rightarrow$ PUF $\rightarrow$ 10110010101111010 Random Numbers

### **On-Chip Randomness from PUF**



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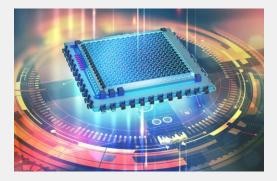
### **Building upon PUF-based Security**

#### PUFrt selected by ARM for v9 CCA security



- PUFrt fully integrates Key generation, Secure Storage and tRNG
- Such Hardware Root-of-Trust is indispensable for all markets spanning cloud to mobile and automotive to IoT.

#### eMemory partners with Intel Foundry Service



- eMemory's OTP, PUF and Security IPs will be available in Intel's leading-edge processes
- PUF-based security enables Zero Trust and enhances supply chain security



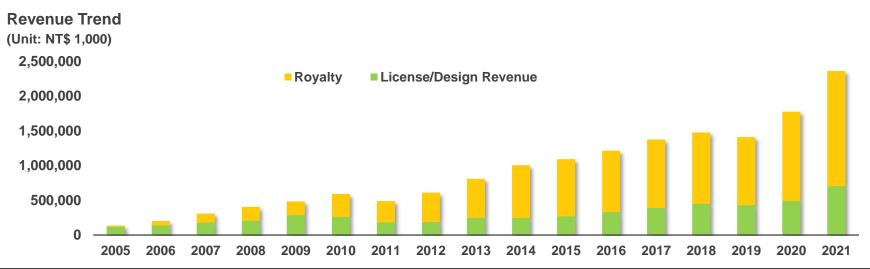
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# Appendix

### **Company Overview**

✓ eMemory is the global leader of embedded non-volatile memory IP



# Founded

Based in Hsinchu, Taiwan. IPO in 2011. Over 41M wafers shipped. Embedded Widely

#### 1000 Patents Issued

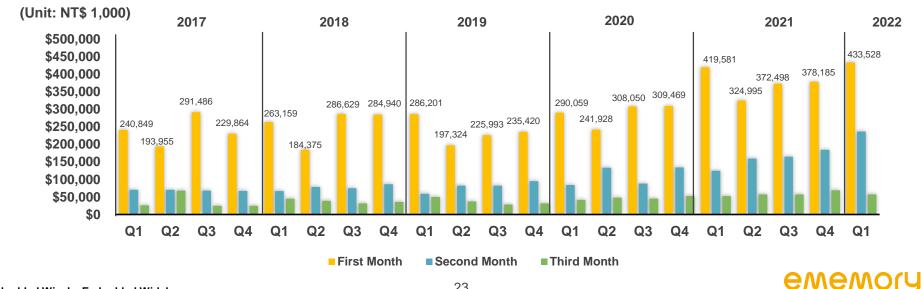
213 pending patents. 297 employees with 68% R&D personnel.

## Best IP Partner

TSMC Best IP Partner Award since 2010.

### **Quarterly Revenue Pattern**

- 1<sup>st</sup> month: Receive License Fees of the month and Royalty from most foundries on previous quarter's wafer  $\checkmark$ shipments.
- 2<sup>nd</sup> month: Receive License Fees of the month and Royalty from other foundries.  $\checkmark$
- 3<sup>rd</sup> month: License Fees Only.  $\checkmark$



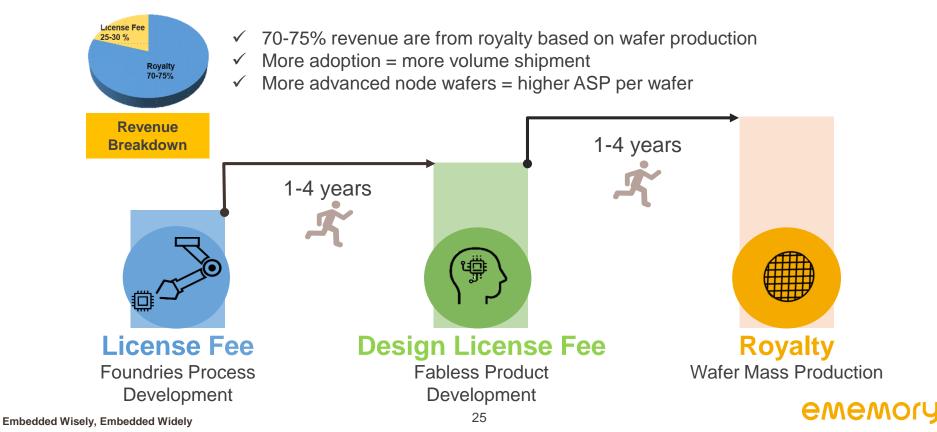
### **Worldwide Customers**

 $\checkmark$  Our IP solutions are adopted by leading foundries, IDMs and fabless worldwide



### **Business Model**

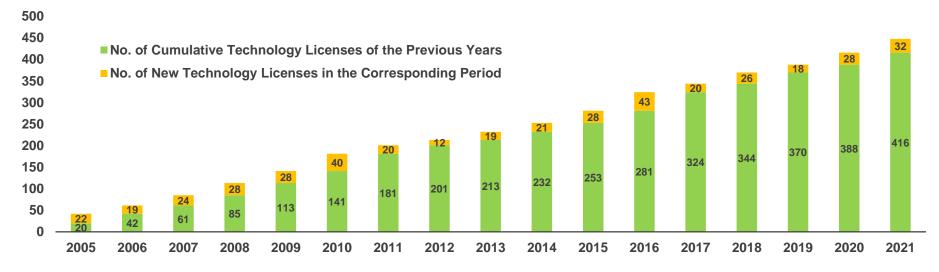
✓ Recurring royalty is the backbone of our business



### **Technology Licenses**

# Year 2016 2017 2018 2019 2020 2021 License 43 20 26 18 28 32

Note: Terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



### **New Technology Under Development**

- ✓ New technologies are being developed for 103 platforms by Q4 2021.
- $\checkmark$  8 licensing contracts were signed.

Technology	5/6nm	7/10nm	12/16nm	22/28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25um
NeoBit	-	-	-	-	-	1	1	9	11	1
NeoFuse	1	1	5	9	2	11	8	2	-	-
PUF-Based	1	-	-	-		1	-	-	-	-
MTP	-	-	-	2	-	6	3	8	20	-

Note: As of Dec 31st, 2021

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### **Technology Development**

#### ✓ Developments by process nodes

12" Fabs	Production	Development	IP Type	Process Type
5/6nm	2	2	OTP, PUF	FF
7/10nm	2	1	OTP, PUF	FF, FF+
12/16nm	6	5	OTP, PUF	FF, FF+, FFC. FFC+, LPP
28/22nm	40	11	OTP, PUF	LP/ULP/ULL, HPC/HPC+, HV-OLED, DRAM, SOI, ReRAM MRAM
40nm	20	2	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, ReRAM
55/65nm	32	19	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, DRAM, CIS, BCD, PM
80/90nm	22	9	OTP, MTP	HV-DDI/OLED, LP, Generic ,BCD, CIS
0.13/0.11um	20	2	OTP, MTP	HV-DDI, BCD, Generic
0.18um	1	8	OTP, MTP	BCD, Generic
Total	145	59		

8" Fabs	Production	Development	IP Type	Process Type
80/90nm	9	3	OTP	HV-DDI, LL, BCD
0.13/0.11um	74	17	OTP, MTP, PUF	HV/HV-MR, BCD, LP/LL, CIS, Green, Flash, SOI, Generic
0.18/0.16/0.152um	219	23	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Generic
0.25um	43	1	OTP, MTP	BCD
0.3/0.35um	52	0	OTP	UHV, BCD
0.4/0.5um	11	0	ОТР	UHV, BCD
Total	408	44		

Note: As of Dec 31st, 2021

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### **Embedded wisely, Embedded widely**

